What is claimed is:

1	1.	A plasma reactor electrode comprising:
2		a first, upper plate for the transfer of RF energy;
3		a second, lower plate for the transfer of RF energy; and
4		a plurality of pins connecting the upper and lower plates to facilitate
5	therm	al conductivity during RF energy transfer.
1	2.	An electrode as claimed in claim 1, further comprising a dielectric cover
2	disposed below the lower plate.	
1	3.	An electrode as claimed in claim 2, wherein said dielectric cover is bonded
2	to said lower plate.	
1	4.	An electrode as claimed in claim 1, wherein said electrode is part of a
2	showerhead a	assembly, with holes extending through said lower plate and said cover.
1	5.	An electrode as claimed in claim 1, further comprising an outer ring
2	surrounding	said upper and lower plates; a first O ring disposed between said upper plate
3	and said oute	er ring; and the second O ring between said lower plate and said outer ring;
4		wherein said first and second O rings, said outer ring, and said first and
5	secor	nd plates are configured to form a plenum chamber; and
6		wherein a plurality of holes are formed to provide uniform gas distribution
7	in co	njunction with said plenum chamber.

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1	6.	An electrode as claimed in claim 2, wherein said dielectric cover is made	
2	of a material selected from the group consisting of ceramic and quartz.		
1	7.	An electrode as claimed in claim 5, wherein said outer ring comprises a	
2	material selected from the group consisting of ceramic and quartz.		
1	8.	An electrode as claimed in claim 1, further comprising a lid disposed over	
2	said upper plate.		
1	9.	An electrode as claimed in claim 8, wherein said lid is made of aluminum.	
1	10.	An electrode as claimed in claim 1, wherein said plurality of pins comprise	
2	aluminum, ar	nd said upper and lower plates comprise aluminum.	
1	11.	A method of forming a plasma reactor electrode, comprising:	
2		attaching a first, upper plate to a second, lower plate with a plurality of	
3	pins;		
4		attaching a dielectric cover below said lower plate; and	
5		providing an outer ring around said upper and lower plates, with respective	
6	first a	and second O rings between said first, upper plate and said outer ring, and	
7	betwe	een said second, lower plate and said ring, so as to form a plenum chamber	
8	amon	g said upper and lower plates, said first and second O rings, and said oute	
9	ring.		
1	12.	A method as claimed in claim 11, wherein said pins, and said first and	

second plates are made of aluminum, and said dielectric cover is made from a material

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- 3 selected from the group consisting of ceramic and quartz, said outer ring being made from
- 4 a material selected from the group consisting of ceramic and quartz.
- 1 13. A method as claimed in claim 11, further comprising providing a lid over said first, upper plate, said lid having an opening for the insertion of processed gas.
- 1 14. A plasma reaction chamber comprising:
- 2 a chamber; and
- a plasma reactor electrode, said electrode comprising a first, upper plate
 for the transfer of RF energy, a second, lower plate for the transfer of RF energy,
 and a plurality of pins for connecting said first and second plates to facilitate
 thermal conductivity during RF energy transfer.
 - 15. A chamber as claimed in claim 14, further comprising an outer ring surrounding said upper and lower plates, and respective O rings between said upper plate and said outer ring, and said lower plate and said outer ring, so as to form a plenum chamber with said upper and lower plates, said outer ring, and said O rings.
 - 16. A chamber as claimed in claim 14, further comprising a dielectric cover attached to said lower plate.